

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

1t1579cs-3#trpbf

(Engineering Calculation)

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**TOTAL MASS (g) : 0.157445**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.004298	1000000	27298.4746094		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.051070	975000	324367.84375		
		Iron (Fe)	7439-89-6	0.001257	24000	7983.75537109		
		Phosphorus (P)	7723-14-0	0.000016	300	101.62297821		
		Zinc (Zn)	7440-66-6	0.000037	700	235.003158569		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.052380</b>	<b>1000000</b>	<b>332688.25</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.002954	1000000	18760.2617188		
		<b>External Plating Total:</b>				<b>0.002954</b>	<b>1000000</b>	<b>18760.2617188</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000419	1000000	2661.25170898		
<b>Internal Plating Total:</b>				<b>0.000419</b>	<b>1000000</b>	<b>2661.25170898</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.001167	750000	7412.12646484		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000389	250000	2470.70874023		
<b>Die Attach Total:</b>				<b>0.001556</b>	<b>1000000</b>	<b>9882.83496094</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.012389	130000	78687.9453125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.079099	830000	502392.28125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.003336	35000	21188.390625		
		Carbon Black (C)	1333-86-4	0.000477	5000	3029.63525391		
		<b>Encapsulation Total:</b>				<b>0.095301</b>	<b>1000000</b>	<b>605298.25</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000537	1000000	3410.72143555		
					<b>TOTAL MASS (g) :</b>	<b>0.157445</b>		